



This certificate is granted and awarded by the authority of the Nadcap Management Council to:

Plascore, Inc

*500A Roosevelt
Zeeland, MI 49464
United States*

This certificate demonstrates conformance and recognition of accreditation for specific services, as listed in www.eAuditNet.com on the Qualified Manufacturers List (QML), to the revision in effect at the time of the audit for:

Non Metallic Materials Manufacturing

Certificate Number: 15950191702
Expiration Date: 31 July 2020
Accreditation Length: 12 Months

Michael J. Hayward
Vice President and Chief Operating Officer



SCOPE OF ACCREDITATION

Non Metallic Materials Manufacturing

Plascore, Inc
500A Roosevelt
Zeeland, MI 49464

This certificate expiration is updated based on periodic audits. The current expiration date and scope of accreditation are listed at: www.eAuditNet.com - Online QML (Qualified Manufacturer Listing).

In recognition of the successful completion of the PRI evaluation process, accreditation is granted to this facility to perform the following:

AC7122/1 Rev B - Nadcap Audit Criteria for Non Metallic Materials Testing – Mechanical Testing

- 1.2.5 Flatwise Compressive, Ambient
- 1.2.6 Flatwise Compressive Non–Ambient
- 1.2.7 Flatwise Compressive Strain Measurement
- 1.21.1 Flatwise tension Sandwich
- 1.22.1 Sandwich Flexure
- 1.25.1 Node Bond Delamination
- 1.3.7 Plate Shear, Ambient
- 1.3.8 Plate Shear, Non–Ambient
- 1.3.9 Plate Shear, Strain Measurement

AC7122/2 Rev A - Nadcap Audit Criteria for Non Metallic Materials Testing – Physical Testing

- 2.2.1 Density/ Specific Gravity

AC7122-R Rev D - Nadcap Audit Criteria for Non Metallic Materials Testing – Raw material manufacturer's captive testing laboratories (Only in conjunction with AC7124) (to be used on audits prior to 24 March 2019)

Class D: Core

AC7124 Rev B - Nadcap Audit Criteria for Non Metallic Materials Manufacturing (Required) (to be used on audits on/after 7 May 2017)

AC7124/4 - Nadcap Audit Criteria for Non Metallic Materials Manufacturing – Core

Manufacturing

Expansion (Non-metallic)

Honeycomb Before Expansion–HoBE (Node bond adhesive, Stacking, Curing)

Resin Dipping & Cure

Sawing/Slicing/Cutting